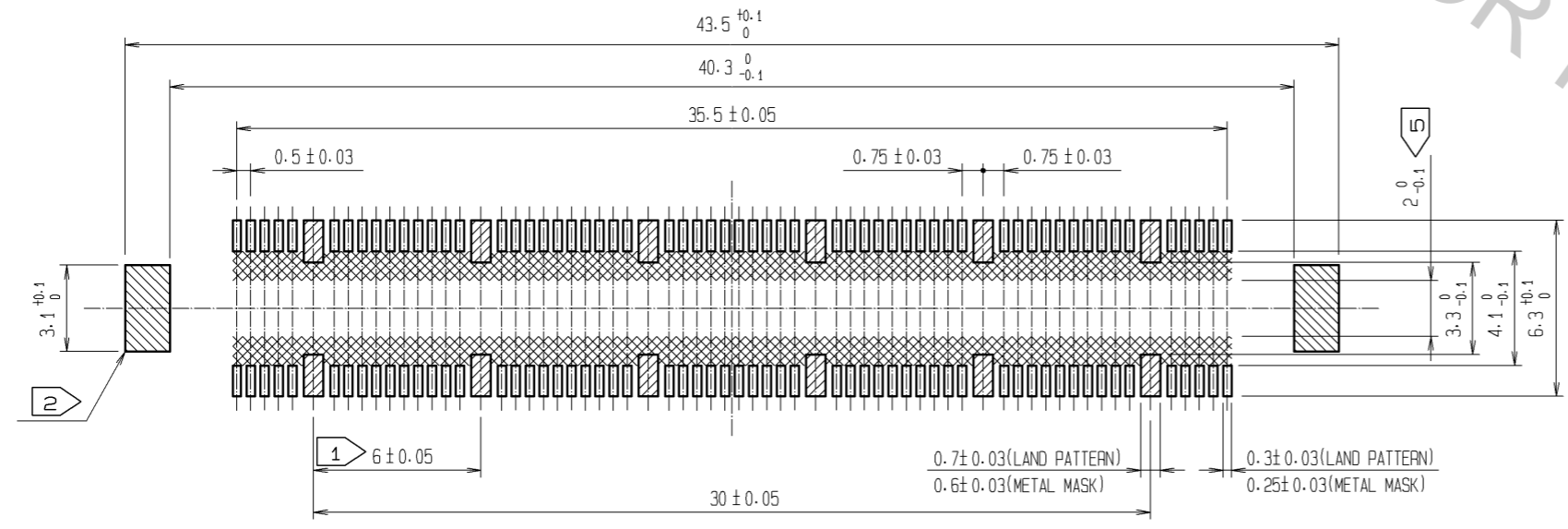


RECOMMENDED LAND PATTERN DIMENSION OF PCB  
(RECOMMENDED METAL MASK THICKNESS: 0.15mm)



- NOTES
- ① 12 HATCHED PARTS: GROUND CIRCUIT.
  - ② 2 HATCHED PARTS: GROUND CIRCUIT.
  - ③ SMT LEAD-COPLANARITY: 0.1 MAX.
  - ④ THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
  - ⑤ MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
  - ⑥ THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

4	PHOSPHOR BRONZE	TIN-PLATING								
3	PHOSPHOR BRONZE		CONTACT AREA: GOLD 0.1μm min.							
1	LCP	BEIGE UL94V-0	LEAD AREA: TIN-PLATING 1μm min.							
			UNDER PLATING: NICKEL 1μm min.							
NO.	MATERIAL	FINISH	REMARKS	NO.	MATERIAL	FINISH	REMARKS			
UNITS			SCALE	COUNT	DESCRIPTION OF REVISIONS			DESIGNED	CHECKED	DATE
mm			4 : 1	△						
<b>HRS</b> HIROSE ELECTRIC CO., LTD.			APPROVED: HS. OKAWA	08.06.26	DRAWING NO.		EDC3-151966-25			
			CHECKED: HT. YAMAGUCHI	08.06.25	PART NO.		FX10B-120P/12-SV1(71)			
			DESIGNED: SY. KAMIGA	08.06.23	CODE NO.		CL570-0123-2-71			
			DRAWN: HK. SUNADORI	08.06.17			△ 1/1			